

# Inndisk Coporation

IGPCB0110\_0201


M2 1113 BGA SSD on M.2 2230 Board

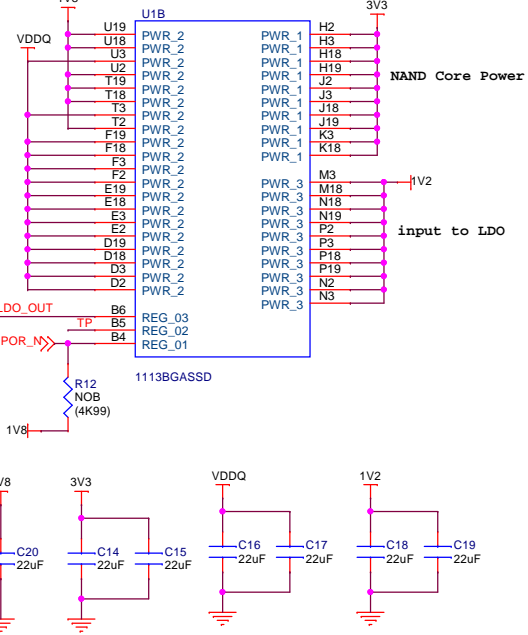
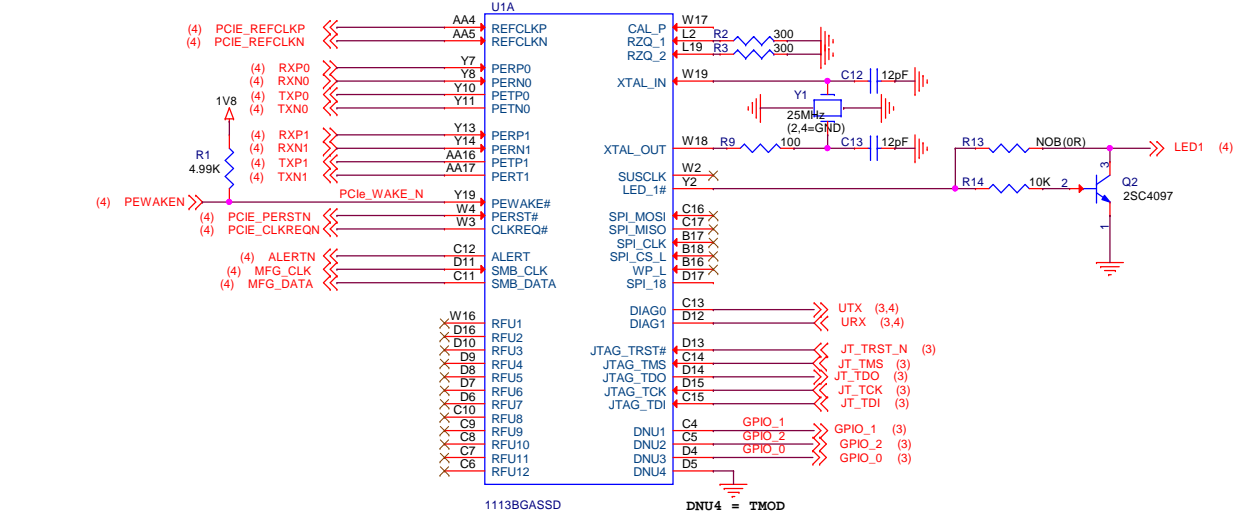
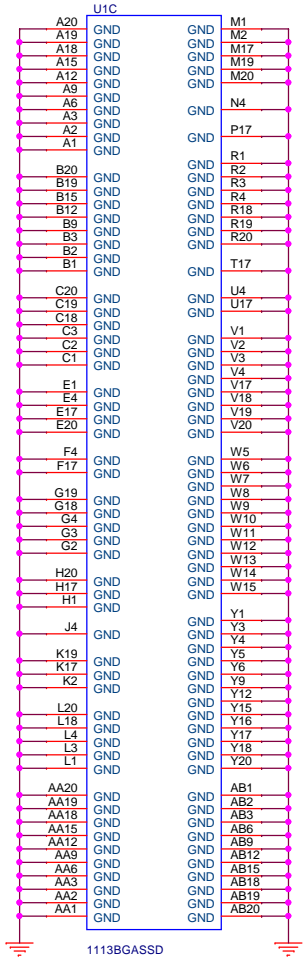
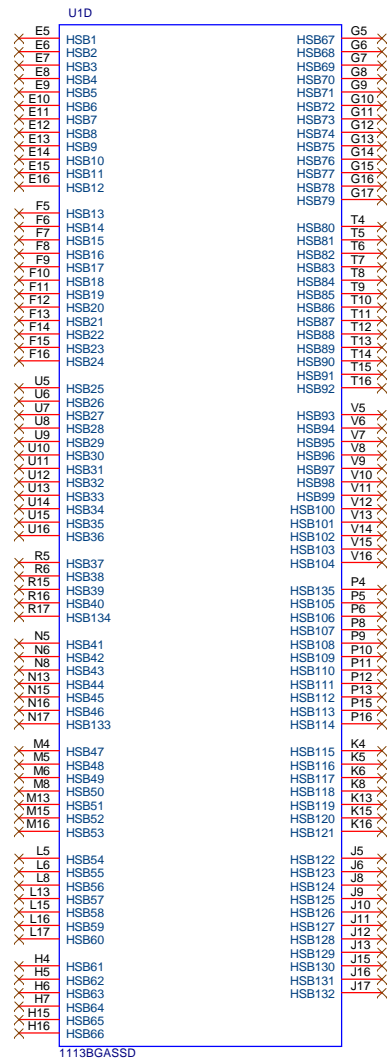
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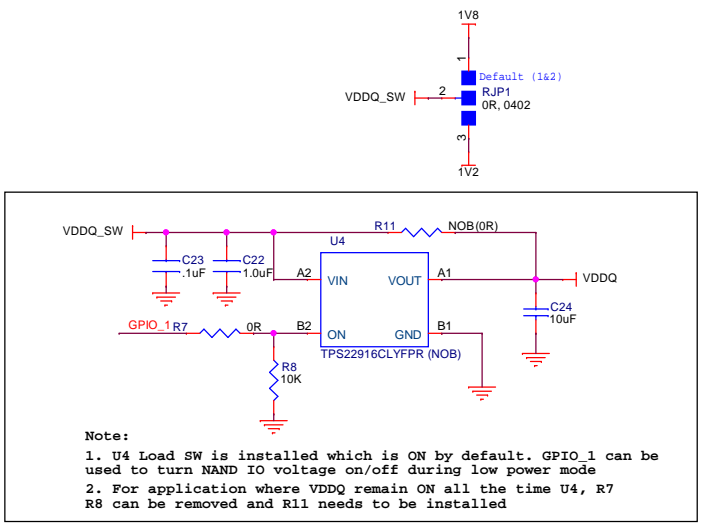
## Revision History

Date	Item	Change list	Purpose
2020/05/19	1	Initial release	
	2		
	3		
	1		
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	4		

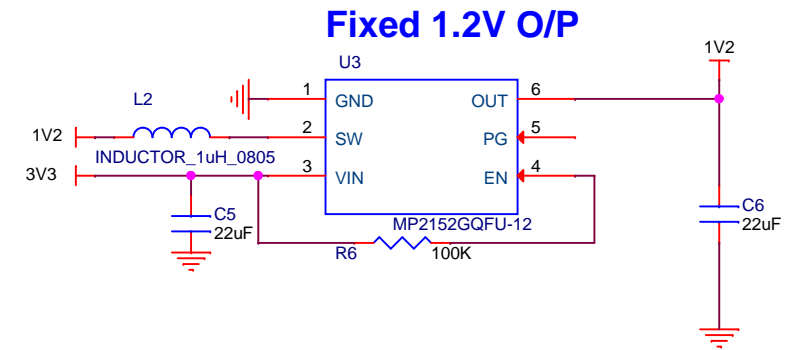
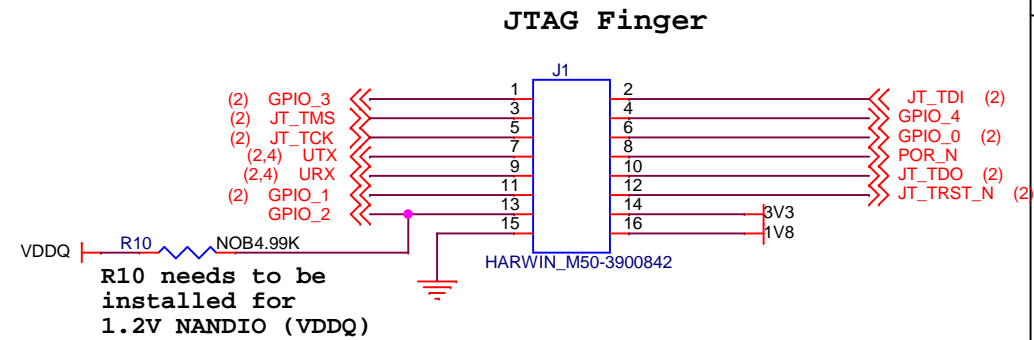
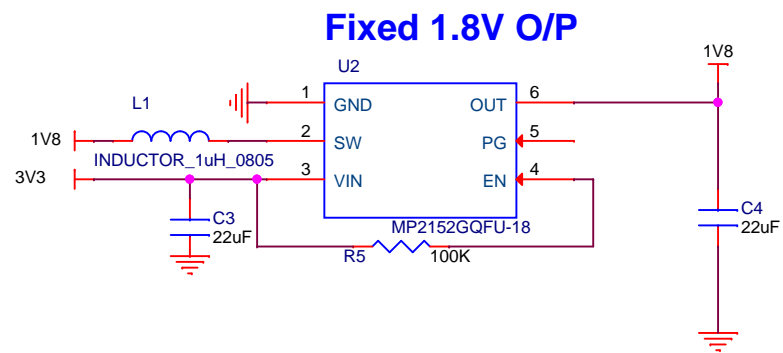
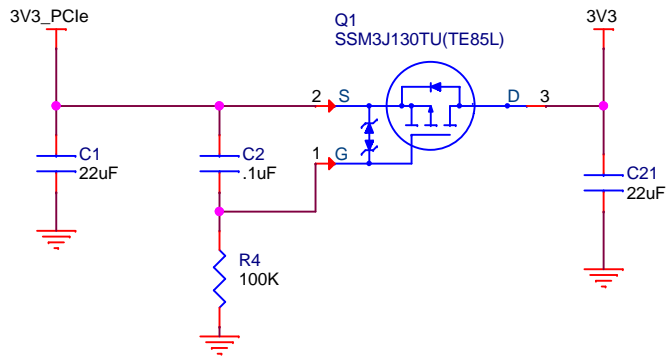
	Project Code: JE12
	Version: A0
Project Name: nanoSSD PCIe 3TE7 Reference design	IGPCB0110_0201 : Cover Page IGPCB0110_0201
Designer: Jerry	Page Size: A4
Date: Tuesday, May 19, 2020	Sheet 1 of 4 Rev



Note:  
 1. Cap for 3.3V, 1.8V, 1.2V are on the package  
 2. If the caps are big to be placed inside package it can be placed on the Host Board. The determination is to be made based on current use



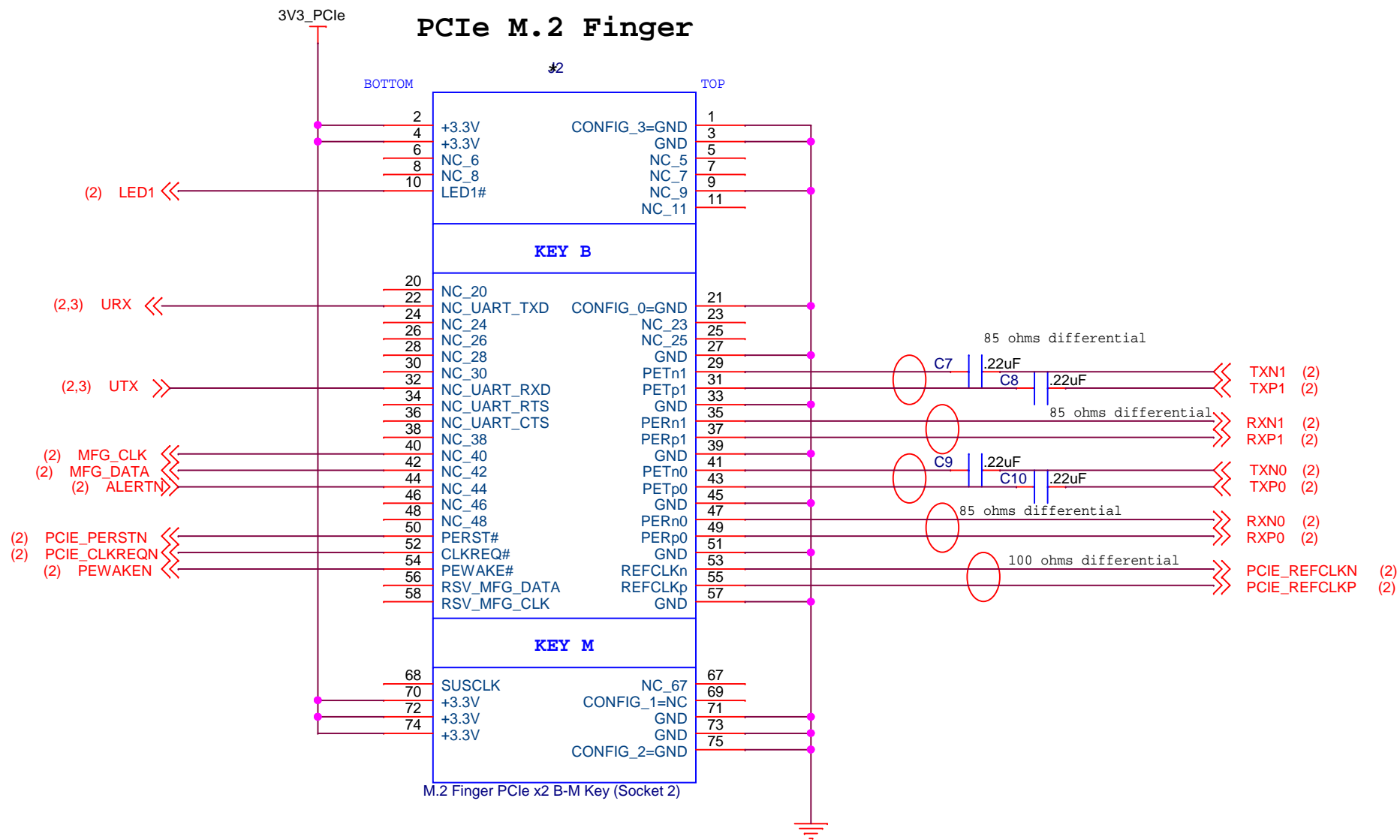
Note:  
 1. U4 Load SW is installed which is ON by default. GPIO\_1 can be used to turn NAND IO voltage on/off during low power mode  
 2. For application where VDDQ remain ON all the time U4, R7 R8 can be removed and R11 needs to be installed



Half-ring cut-out to screw board to chassis

	Project Code: JE12
	Version: A0
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Designer: Jerry	Page Size: A4
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# PCIe M.2 Finger



Project Code: JE12

Version: A0

Project Name: nanoSSD PCIe 3TE7 Reference design  
 IGPCB0110\_0201 : M.2 I/F  
 IGPCB0110\_0201

Designer: Jerry  
 Page Size: A

Date: Tuesday, May 19, 2020  
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